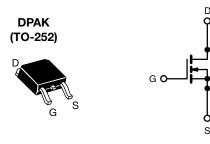
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6			
Q _g max. (nC)	48				
Q _{gs} (nC)	6				
Q _{gd} (nC)	11				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
	SiHD6N65E-GE3			
Lood (Db) free and Lielenen free	SiHD6N65ET1-GE3			
Lead (Pb)-free and Halogen-free	SiHD6N65ET4-GE3			
	SiHD6N65ET5-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	V	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T. 150 °C)	V at 10 V	T _C = 25 °C		7		
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	А	
Pulsed Drain Current ^a			I _{DM}	18		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	56	mJ	
Maximum Power Dissipation			PD	78	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	37			
Reverse Diode dV/dt ^d			27	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,~I_{AS}$ = 2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,\,dI/dt$ = 100 A/µs, starting T_J = 25 °C.

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1 For technical questions, contact: <u>hvm@vishay.com</u> www.vishay.com

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	_		62 1.6				
Maximum Junction-to-Case (Drain)	R _{thJC}	-				°C/W		
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static	1				•			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.73	-	V/°0
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
Osta Course Laskans		$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	V _{DS} = 650 V, V _{GS} = 0 V		-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 V	, V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		I _D = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 3 A		-	2	-	S	
Dynamic	•				-	•	•	•
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	820	-	pF	
Output Capacitance	C _{oss}			-	40	-		
Reverse Transfer Capacitance	C _{rss}			-	4	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	36	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	117	-		
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 3 A, V _{DS} = 520 V		-	24	48	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$			-	6	-	
Gate-Drain Charge	Q _{gd}				-	11	-	
Turn-On Delay Time	t _{d(on)}				-	14	28	
Rise Time	t _r	V_{DD} = 520 V, I_D = 3 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	12	24	- ns	
Turn-Off Delay Time	t _{d(off)}			-	30	60		
Fall Time	t _f			-	20	40		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.4	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	_	
Pulsed Diode Forward Current	I _{SM}			-	-	18	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	-	1.3	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 3 \text{ A},$ $dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	237	-	ns	
Reverse Recovery Charge	Q _{rr}			-	2.2	-	μ	
Reverse Recovery Current	I _{RRM}			L			P. C	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

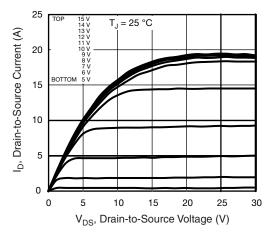


Fig. 1 - Typical Output Characteristics

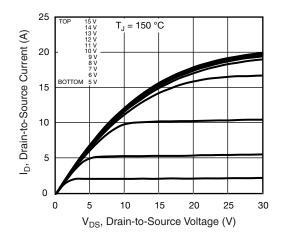


Fig. 2 - Typical Output Characteristics

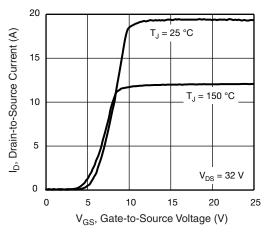


Fig. 3 - Typical Transfer Characteristics

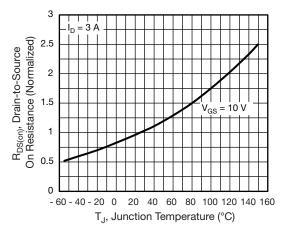


Fig. 4 - Normalized On-Resistance vs. Temperature

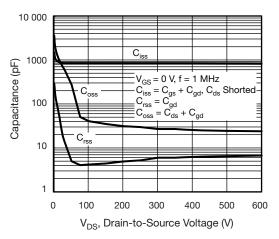


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

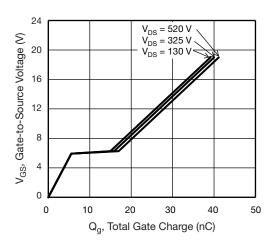


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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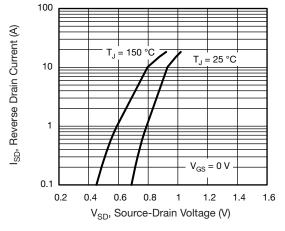


Fig. 7 - Typical Source-Drain Diode Forward Voltage

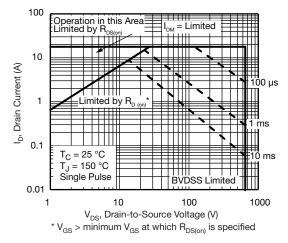


Fig. 8 - Maximum Safe Operating Area

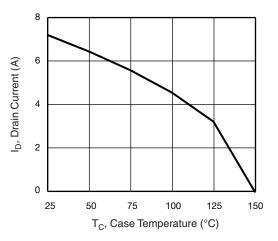


Fig. 9 - Maximum Drain Current vs. Case Temperature

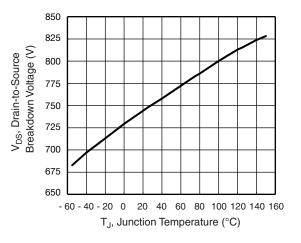
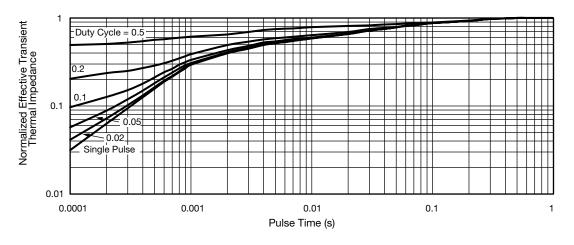


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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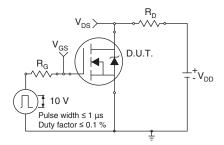


Fig. 12 - Switching Time Test Circuit

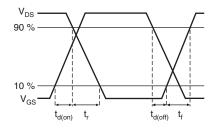


Fig. 13 - Switching Time Waveforms

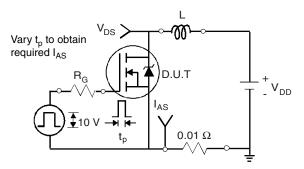


Fig. 14 - Unclamped Inductive Test Circuit

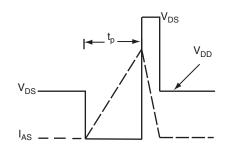


Fig. 15 - Unclamped Inductive Waveforms

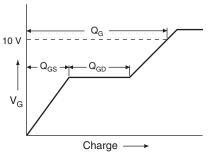


Fig. 16 - Basic Gate Charge Waveform

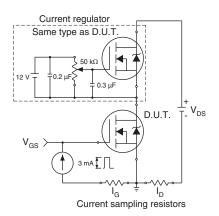


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

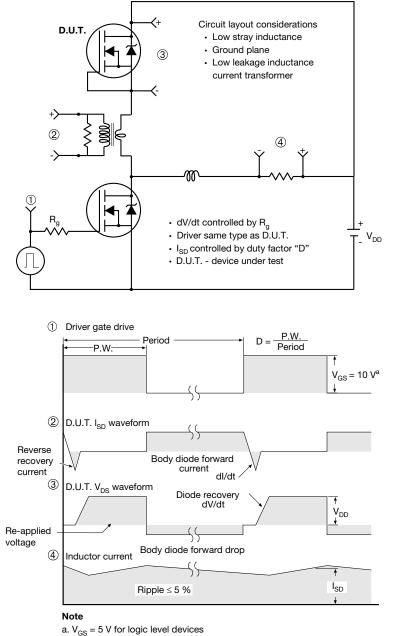
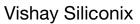


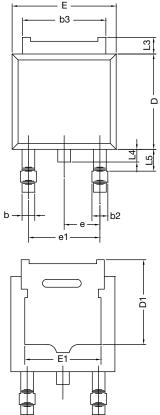
Fig. 18 - For N-Channel

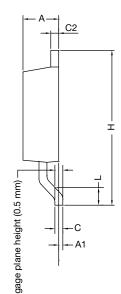
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TO-252AA Case Outline





	MILLIN	IETERS	INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	4.10	-	0.161	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28 BSC		0.090 BSC			
e1	4.56	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.01	1.52	0.040	0.060		
ECN: T16- DWG: 534	0236-Rev. P, ⁻ 7	16-May-16				

Notes

• Dimension L3 is for reference only.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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